

IRF8734PbF

HEXFET® Power MOSFET

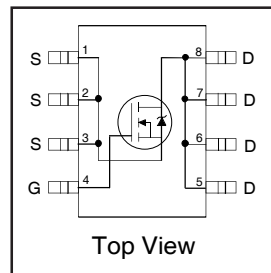
Applications

- Synchronous MOSFET for Notebook Processor Power
- Synchronous Rectifier MOSFET for Isolated DC-DC Converters in Networking Systems

Benefits

- Very Low $R_{DS(on)}$ at 4.5V V_{GS}
- Low Gate Charge
- Fully Characterized Avalanche Voltage and Current
- 100% Tested for R_G
- Lead-Free

| V_{DSS} | $R_{DS(on)}$ max | Qg (typ.) |
|-----------|--------------------------------|-----------|
| 30V | 3.5m Ω @ $V_{GS} = 10V$ | 20nC |



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|--------------------------|--|--------------|---------------|
| V_{DS} | Drain-to-Source Voltage | 30 | V |
| V_{GS} | Gate-to-Source Voltage | ± 20 | |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 21 | A |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 17 | |
| I_{DM} | Pulsed Drain Current ① | 168 | |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation ④ | 2.5 | W |
| $P_D @ T_A = 70^\circ C$ | Power Dissipation ④ | 1.6 | |
| | Linear Derating Factor | 0.02 | W/ $^\circ C$ |
| T_J | Operating Junction and | -55 to + 150 | $^\circ C$ |
| T_{STG} | Storage Temperature Range | | |

Thermal Resistance

| | Parameter | Typ. | Max. | Units |
|-----------------|--------------------------|------|------|--------------|
| $R_{\theta JL}$ | Junction-to-Drain Lead ⑤ | — | 20 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient ④ | — | 50 | |

Notes ① through ⑤ are on page 10

ORDERING INFORMATION:

See detailed ordering and shipping information on the last page of this data sheet.

IRF8734PbF

International
IR Rectifier

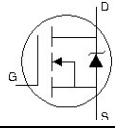
Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|------------------------------|--------------------------------------|------|-------|------|------------|--|
| BV_{DSS} | Drain-to-Source Breakdown Voltage | 30 | — | — | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| $\Delta BV_{DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | — | 0.023 | — | V/°C | Reference to $25^\circ\text{C}, I_D = 1mA$ |
| $R_{DS(on)}$ | Static Drain-to-Source On-Resistance | — | 2.9 | 3.5 | m Ω | $V_{GS} = 10V, I_D = 21A$ ③ |
| | | — | 4.2 | 5.1 | | $V_{GS} = 4.5V, I_D = 17A$ ③ |
| $V_{GS(th)}$ | Gate Threshold Voltage | 1.35 | 1.80 | 2.35 | V | $V_{DS} = V_{GS}, I_D = 50\mu A$ |
| $\Delta V_{GS(th)}$ | Gate Threshold Voltage Coefficient | — | -6.5 | — | mV/°C | |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | 1.0 | μA | $V_{DS} = 24V, V_{GS} = 0V$ |
| | | — | — | 150 | | $V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | 100 | nA | $V_{GS} = 20V$ |
| | Gate-to-Source Reverse Leakage | — | — | -100 | | $V_{GS} = -20V$ |
| g_{fs} | Forward Transconductance | 85 | — | — | S | $V_{DS} = 15V, I_D = 17A$ |
| Q_g | Total Gate Charge | — | 20 | 30 | nC | $V_{DS} = 15V$ $V_{GS} = 4.5V$ $I_D = 17A$ See Figs. 16a & 16b |
| Q_{gs1} | Pre-Vth Gate-to-Source Charge | — | 5.2 | — | | |
| Q_{gs2} | Post-Vth Gate-to-Source Charge | — | 2.3 | — | | |
| Q_{gd} | Gate-to-Drain Charge | — | 6.9 | — | | |
| Q_{godr} | Gate Charge Overdrive | — | 5.4 | — | | |
| Q_{sw} | Switch Charge ($Q_{gs2} + Q_{gd}$) | — | 9.2 | — | | |
| Q_{oss} | Output Charge | — | 15 | — | nC | $V_{DS} = 16V, V_{GS} = 0V$ |
| R_G | Gate Resistance | — | 1.7 | 3.1 | Ω | |
| $t_{d(on)}$ | Turn-On Delay Time | — | 13 | — | ns | $V_{DD} = 15V, V_{GS} = 4.5V$ ③ $I_D = 17A$ $R_G = 1.8\Omega$ See Figs. 15a & 15b |
| t_r | Rise Time | — | 16 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 15 | — | | |
| t_f | Fall Time | — | 8.0 | — | | |
| C_{iss} | Input Capacitance | — | 3175 | — | pF | $V_{GS} = 0V$ |
| C_{oss} | Output Capacitance | — | 627 | — | | $V_{DS} = 15V$ |
| C_{rss} | Reverse Transfer Capacitance | — | 241 | — | | $f = 1.0MHz$ |

Avalanche Characteristics

| | Parameter | Typ. | Max. | Units |
|----------|---------------------------------|------|------|-------|
| E_{AS} | Single Pulse Avalanche Energy ② | — | 216 | mJ |
| I_{AR} | Avalanche Current ① | — | 17 | A |

Diode Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------|--|------|------|------|-------|--|
| I_S | Continuous Source Current (Body Diode) | — | — | 3.1 | A | MOSFET symbol showing the integral reverse p-n junction diode.  |
| I_{SM} | Pulsed Source Current (Body Diode) ① | — | — | 168 | | |
| V_{SD} | Diode Forward Voltage | — | — | 1.0 | V | $T_J = 25^\circ\text{C}, I_S = 17A, V_{GS} = 0V$ ③ |
| t_{rr} | Reverse Recovery Time | — | 20 | 30 | ns | $T_J = 25^\circ\text{C}, I_F = 17A, V_{DD} = 15V$ |
| Q_{rr} | Reverse Recovery Charge | — | 25 | 38 | nC | $di/dt = 345A/\mu s$ ③ |

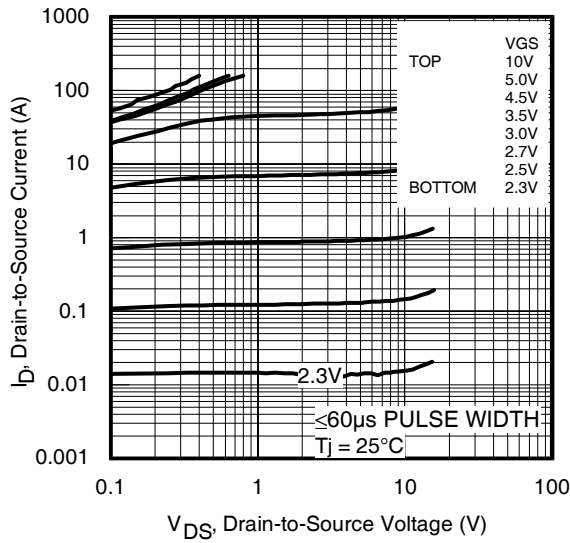


Fig 1. Typical Output Characteristics

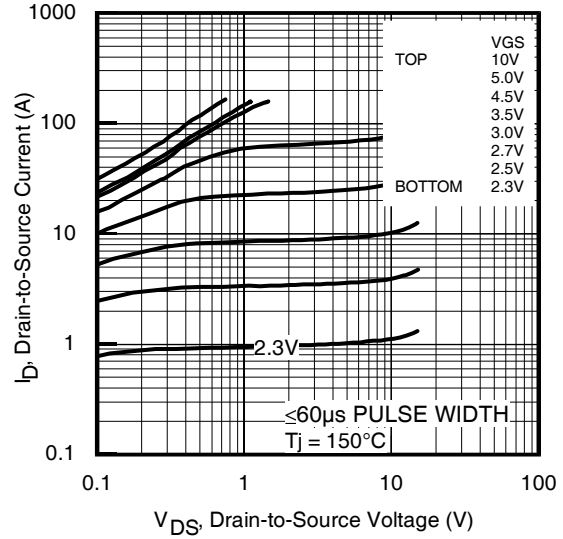


Fig 2. Typical Output Characteristics

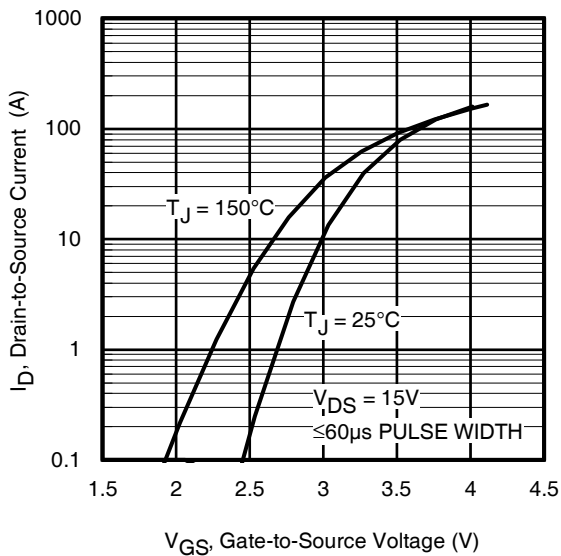


Fig 3. Typical Transfer Characteristics

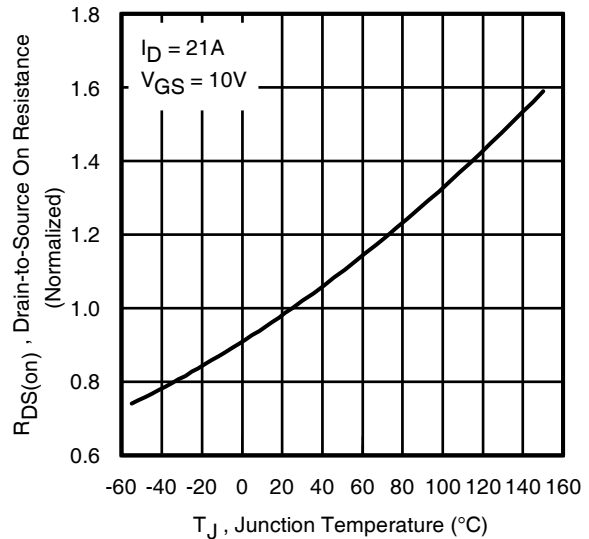


Fig 4. Normalized On-Resistance Vs. Temperature

IRF8734PbF

International
IR Rectifier

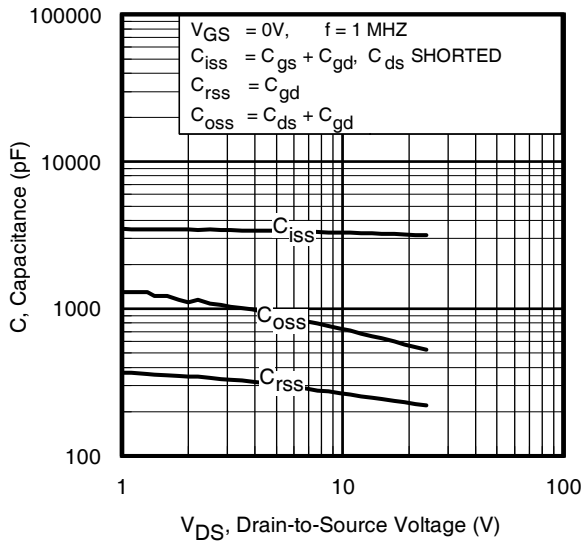


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

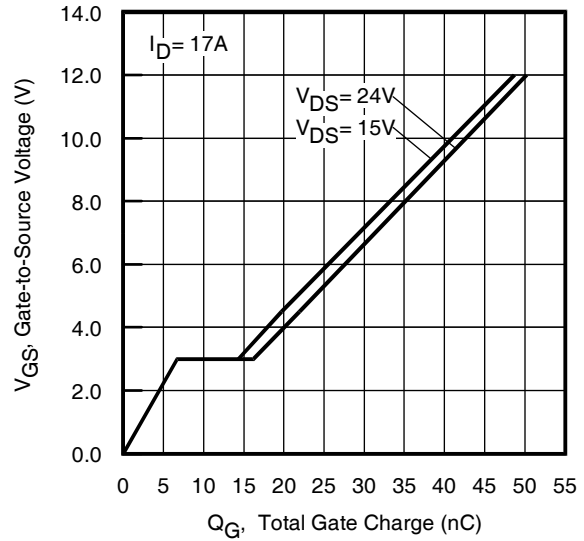


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

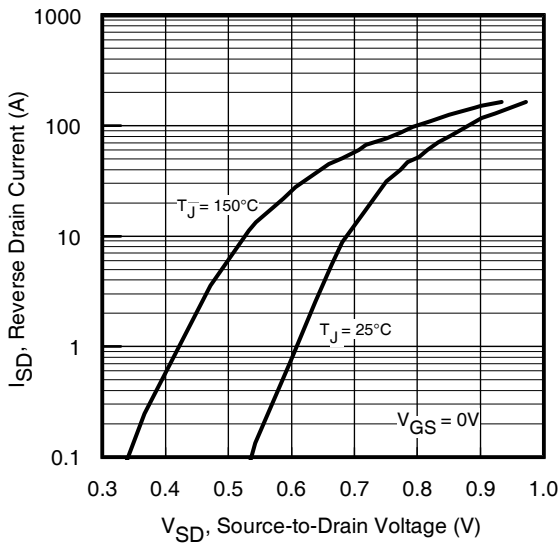


Fig 7. Typical Source-Drain Diode Forward Voltage

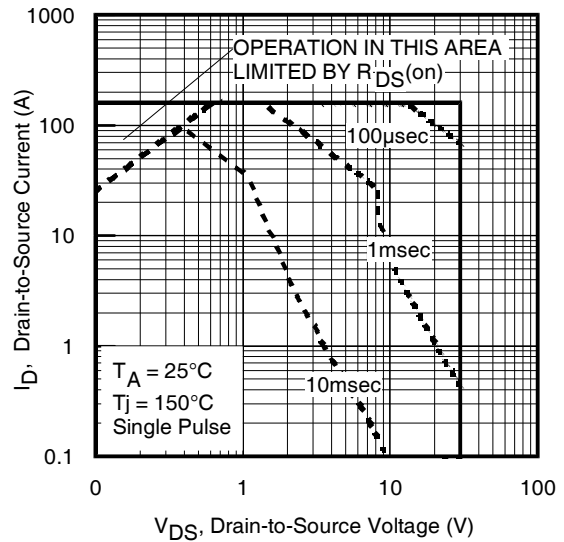


Fig 8. Maximum Safe Operating Area

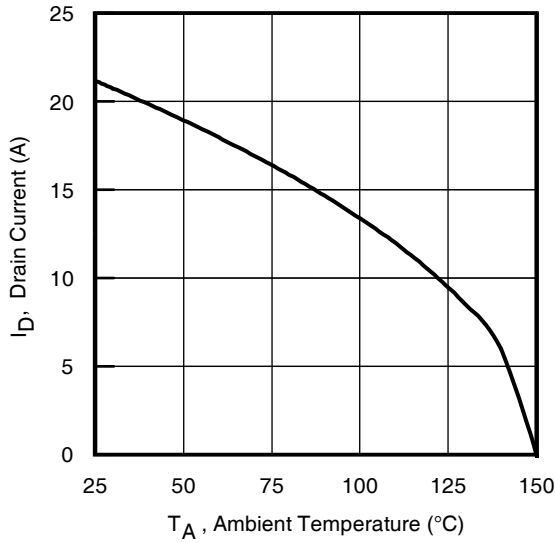


Fig 9. Maximum Drain Current Vs. Ambient Temperature

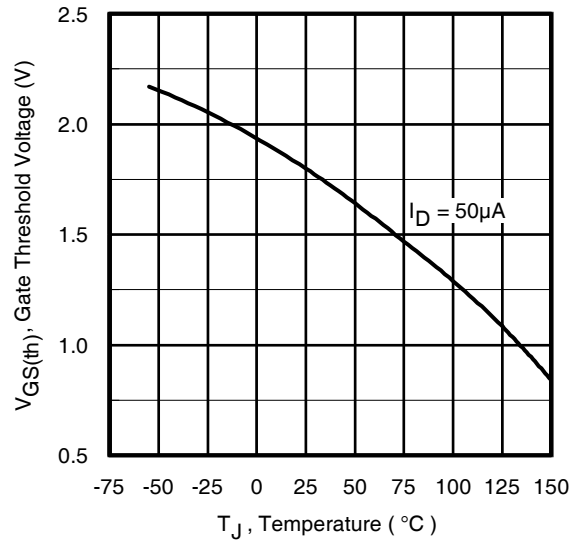


Fig 10. Threshold Voltage Vs. Temperature

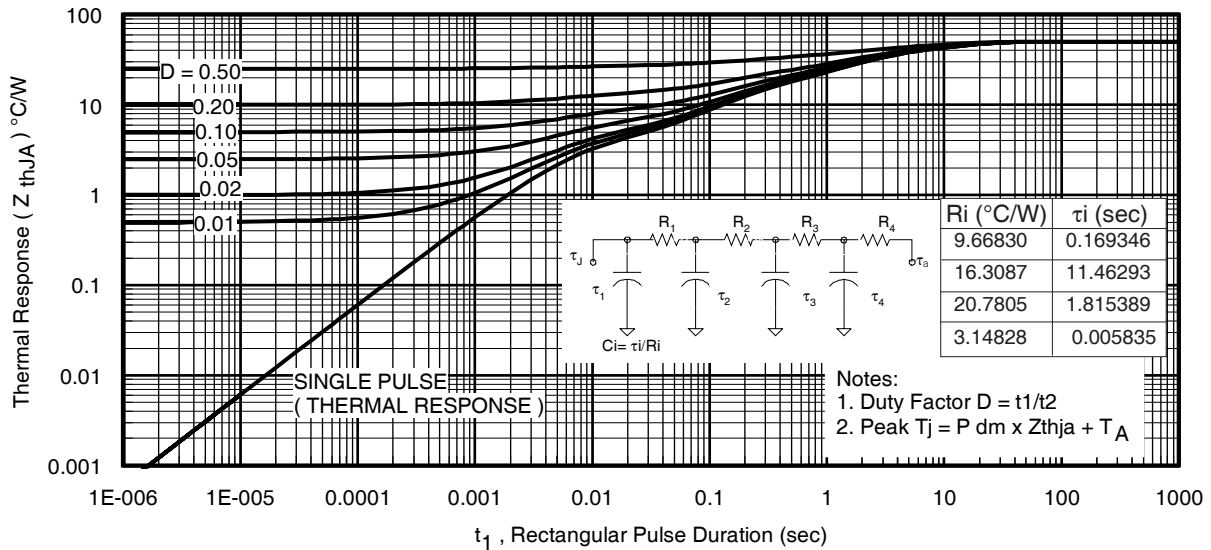


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

IRF8734PbF

International
IR Rectifier

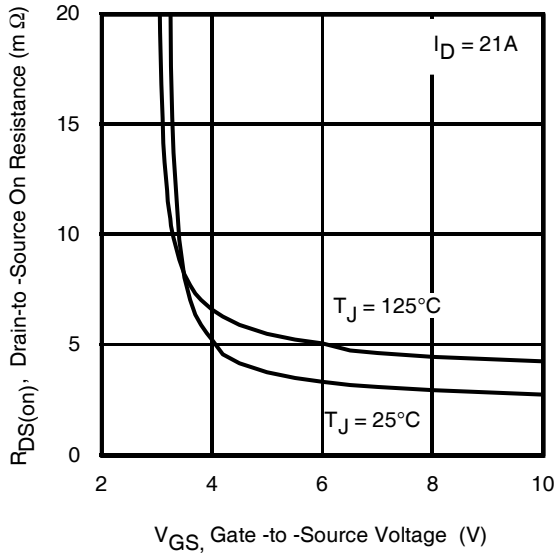


Fig 12. On-Resistance Vs. Gate Voltage

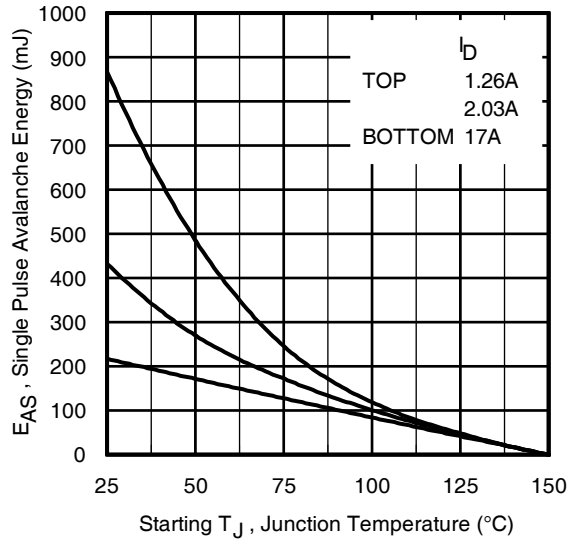


Fig 13c. Maximum Avalanche Energy Vs. Drain Current

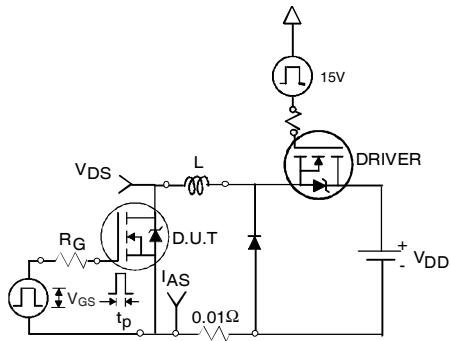


Fig 14a. Unclamped Inductive Test Circuit

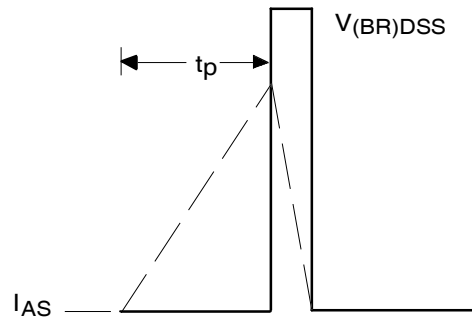


Fig 14b. Unclamped Inductive Waveforms

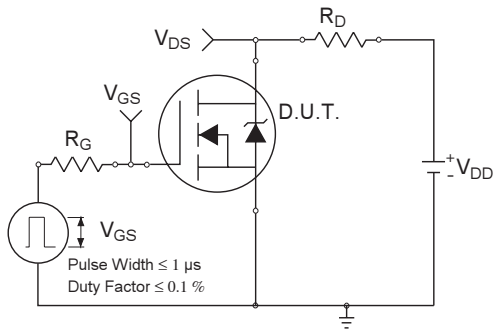


Fig 15a. Switching Time Test Circuit

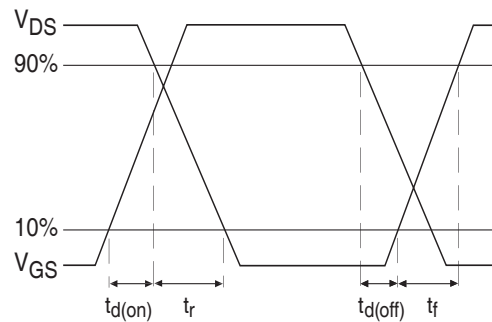


Fig 15b. Switching Time Waveforms

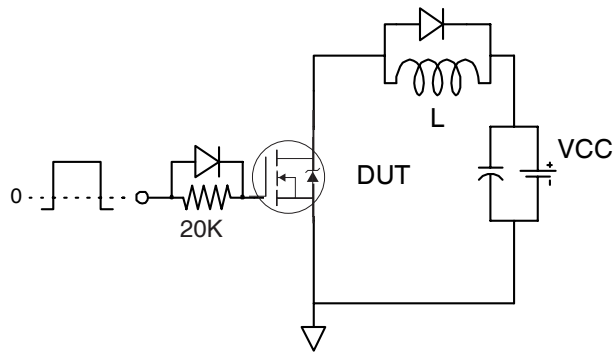


Fig 16a. Gate Charge Test Circuit

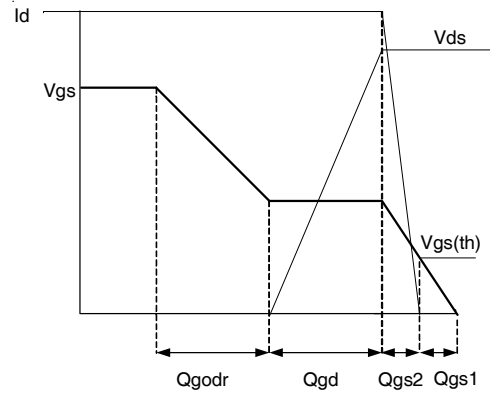


Fig 16b. Gate Charge Waveform

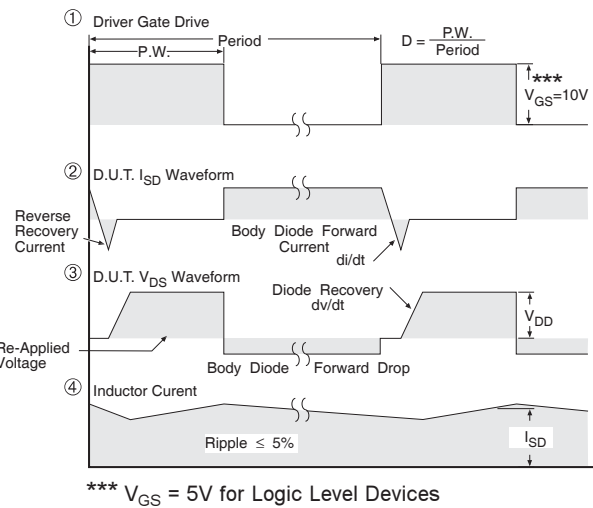
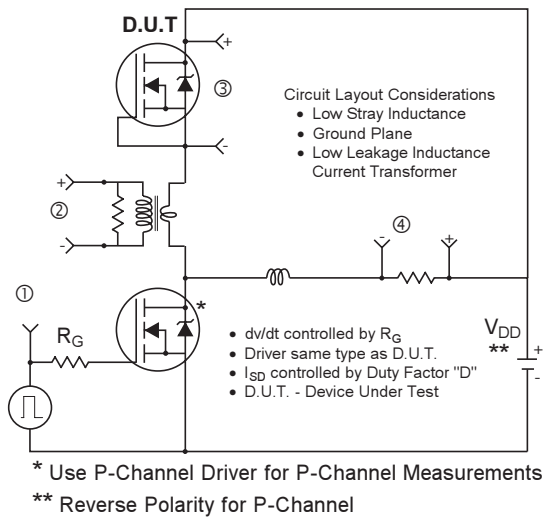


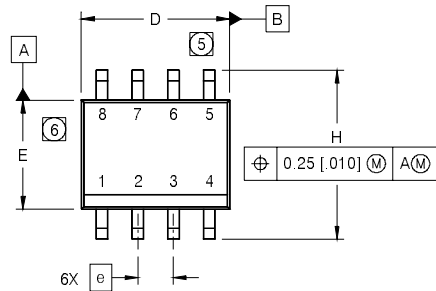
Fig 17. Diode Reverse Recovery Test Circuit for HEXFET® Power MOSFETs

IRF8734PbF

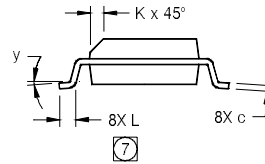
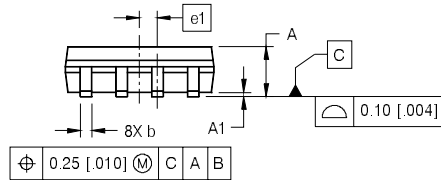
International
IR Rectifier

SO-8 Package Outline (Mofset & Fetky)

Dimensions are shown in millimeters (inches)



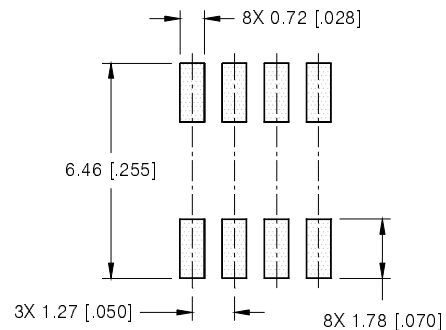
| DIM | INCHES | | MILLIMETERS | |
|-----|------------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | .0532 | .0688 | 1.35 | 1.75 |
| A1 | .0040 | .0098 | 0.10 | 0.25 |
| b | .013 | .020 | 0.33 | 0.51 |
| c | .0075 | .0098 | 0.19 | 0.25 |
| D | .189 | .1968 | 4.80 | 5.00 |
| E | .1497 | .1574 | 3.80 | 4.00 |
| e | .050 BASIC | | 1.27 BASIC | |
| e1 | .025 BASIC | | 0.635 BASIC | |
| H | .2284 | .2440 | 5.80 | 6.20 |
| K | .0099 | .0196 | 0.25 | 0.50 |
| L | .016 | .050 | 0.40 | 1.27 |
| y | 0° | 8° | 0° | 8° |



NOTES:

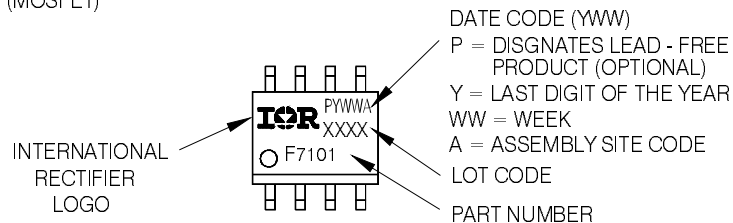
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- ⑤ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [0.006].
- ⑥ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [0.010].
- ⑦ DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

FOOTPRINT



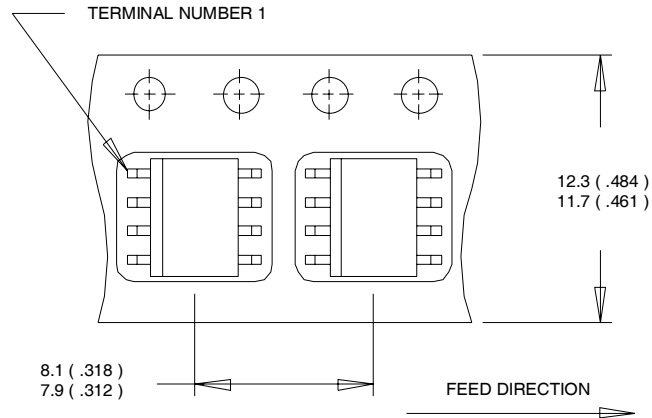
SO-8 Part Marking Information

EXAMPLE: THIS IS AN IRF7101 (MOSFET)

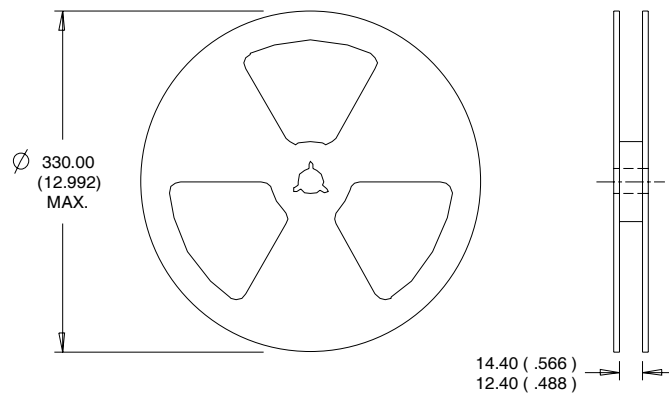


Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

SO-8 Tape and Reel (Dimensions are shown in millimeters (inches))



- NOTES:
1. CONTROLLING DIMENSION : MILLIMETER.
 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES :
1. CONTROLLING DIMENSION : MILLIMETER.
 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

IRF8734PbF

International
IR Rectifier

| Orderable part number | Package Type | Standard Pack | | Note |
|-----------------------|--------------|---------------|----------|------|
| | | Form | Quantity | |
| IRF8734PbF | SO-8 | Tube/Bulk | 95 | |
| IRF8734TRPbF | SO-8 | Tape and Reel | 4000 | |

Qualification Information[†]

| | | |
|----------------------------|---|--|
| Qualification level | Consumer ^{††} | |
| | (per JEDEC JESD47F ^{†††} guidelines) | |
| Moisture Sensitivity Level | SO-8 | MSL1 (per JEDEC J-STD-020D ^{†††}) |
| RoHS Compliant | Yes | |

† Qualification standards can be found at International Rectifier's web site
<http://www.irf.com/product-info/reliability>

†† Higher qualification ratings may be available should the user have such requirements.
Please contact your International Rectifier sales representative for further information:
<http://www.irf.com/whoto-call/salesrep/>

††† Applicable version of JEDEC standard at the time of product release.

Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 1.69\text{mH}$
 $R_G = 25\Omega$, $I_{AS} = 16\text{A}$.
- ③ Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ④ When mounted on 1 inch square copper board
- ⑤ R_θ is measured at T_J of approximately 90°C .

Data and specifications subject to change without notice

International
IR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.02/2009

AMEYA360

Components Supply Platform

Authorized Distribution Brand :



Website :

Welcome to visit www.ameya360.com

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd
Minhang District, Shanghai , China

➤ Sales :

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype [ameyasales1](#) [ameyasales2](#)

➤ Customer Service :

Email service@ameya360.com

➤ Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com